

6/7/2011

PRODUCT RELIABILITY REPORT FOR

71M6543G

Maxim Integrated Products

4401 South Beltwood Parkway Dallas, TX 75244-3292

Prepared by:

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Conclusion:

The following qualification successfully meets the quality and reliability standards required of all Maxim products:

71M6543G

In addition, Maxim's continuous reliability monitor program ensures that all outgoing product will continue to meet Maxim's quality and reliability standards. The current status of the reliability monitor program can be viewed at http://www.maxim-ic.com/TechSupport /dsreliability.html.

Device Description:

A description of this device can be found in the product data sheet. You can find the product data sheet at http://dbserv.maxim-ic.com/l_datasheet3.cfm.

Reliability Derating:

The Arrhenius model will be used to determine the acceleration factor for failure mechanisms that are temperature accelerated.

AfT = exp((Ea/k)*(1/Tu - 1/Ts)) = tu/ts AfT = Acceleration factor due to Temperature tu = Time at use temperature (e.g. 55°C) ts = Time at stress temperature (e.g. 125°C) k = Boltzmann's Constant (8.617 x 10-5 eV/°K) Tu = Temperature at Use (°K) Ts = Temperature at Stress (°K) Ea = Activation Energy (e.g. 0.7 ev)

The activation energy of the failure mechanism is derived from either internal studies or industry accepted standards, or activation energy of 0.7ev will be used whenever actual failure mechanisms or their activation energies are unknown. All deratings will be done from the stress ambient temperature to the use ambient temperature.

An exponential model will be used to determine the acceleration factor for failure mechanisms, which are voltage accelerated.

AfV = exp(B*(Vs - Vu)) AfV = Acceleration factor due to Voltage Vs = Stress Voltage (e.g. 7.0 volts) Vu = Maximum Operating Voltage (e.g. 5.5 volts) B = Constant related to failure mechanism type (e.g. 1.0, 2.4, 2.7, etc.)

The Constant, B, related to the failure mechanism is derived from either internal studies or industry accepted standards, or a B of 1.0 will be used whenever actual failure mechanisms or their B are unknown. All deratings will be done from the stress voltage to the maximum operating voltage. Failure rate data from the operating life test is reported using a Chi-Squared statistical model at the 60% or 90% confidence level (Cf).

The failure rate, Fr, is related to the acceleration during life test by:

Fr = X/(ts * AfV * AfT * N * 2)X = Chi-Sq statistical upper limit N = Life test sample size Failure Rates are reported in FITs (Failures in Time) or MTTF (Mean Time To Failure). The FIT rate is related to MTTF by:

MTTF = 1/Fr

NOTE: MTTF is frequently used interchangeably with MTBF.

The calculated failure rate for this device/process is:

		00000	FITO.	4.0					
FAILURE RATE:	MTTF (YRS):	28293	FITS:	4.0					
	DEVICE HOURS:	227099550	FAILS:	0					
Only data from Operating Life or similar stresses are used for this calculation.									
The parameters used to calculate this failure rate are as follows:									
Cf: 60% Ea	: 0.7 B: 0	Tu: 2	<u>25</u> ℃	Vu: 3.6 Volts					

The reliability data follows. At the start of this data is the device information. The next section is the detailed reliability data for each stress. The reliability data section includes the latest data available and may contain some generic data. **Bold** Product Number denotes specific product data.

Device Informati	on:									
Process:		TSMC 0.25um, Mixed signal, Embedded flash, General Purpose, Double								
			ad metal, 2							
Passivation:			l = 1000nm/	/700nm						
	Die Size: 126 x 176									
Number of Transistors: 1702915 Interconnect: Aluminum / 0.5% Co										
Interconnect: Gate Oxide Thi	ckness.		JIII / 0.5% C	opper						
	011035.	1011								
ESD HBM										
DESCRIPTION	DATE	CODE/PRODU	CT/LOT	CONDITION	RE.	ADPOIN	QTY	FAILS	FA#	
ESD SENSITIVITY	1052	71M6543G	445AN	JESD22-A114 HBM 500 VOLTS	1	PUL'S	5	0		
ESD SENSITIVITY	1052	71M6543G	445AN	JESD22-A114 HBM 1000 VOLTS	1	PUL'S	5	0		
ESD SENSITIVITY	1052	71M6543G	445AN	JESD22-A114 HBM 1500 VOLTS	1	PUL'S	5	0		
ESD SENSITIVITY	1052	71M6543G	445AN	JESD22-A114 HBM 2000 VOLTS	1	PUL'S	5	0		
ESD SENSITIVITY	1052	71M6543G	445AN	JESD22-A114 HBM 2500 VOLTS	1	PUL'S	5	0		
ESD SENSITIVITY	1052	71M6543G	445AN	JESD22-A114 HBM 3000 VOLTS	1	PUL'S	5	0		
					Total:			0		
LATCH-UP										
DESCRIPTION	DATE	CODE/PRODU	CT/LOT	CONDITION	RE	ADPOIN	QTY	FAILS	FA#	
LATCH-UP I	1052	71M6543G	445AN	JESD78A, I-TEST 25C 100mA			6	0		
LATCH-UP I	1052	71M6543G	445AN	JESD78A, I-TEST 25C 250mA			6	0		
LATCH-UP V	1052	71M6543G	445AN	JESD78A, V-SUPPLY TEST 25C			6	0		

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						Total:		0		
OPERATING LIFE										
DESCRIPTION	DATE	CODE/PRODUCT	ſ/LOT	CONE	DITION	READ	POIN	QTY	FAILS	FA#
HIGH TEMP OP LIFE	0222	78M6613	26728	125C,	3.6 VOLTS	1000	HRS	76	0	
HIGH TEMP OP LIFE	1026	71M6103	26803	125C,	3.3 VOLTS	500	HRS	200	0	
HIGH TEMP OP LIFE	1042	71M6543	QB112428A	E 125C,	3.3 VOLTS	500	HRS	100	0	
HIGH TEMP OP LIFE	1052	71M6543G	445AN	125C,	3.6 VOLTS	192	HRS	77	0	
						Total:			0	
FAILURE RATE:		MTTF (YRS): 28	3293	FITS:	4.0				
	D	EVICE HOURS	S: 227099	9550	FAILS:	0				